AMP-LATCH | AMP-LATCH Universal Headers

TE Internal #: 102159-1

AMP-LATCH Universal Headers, Ribbon Cable Connectors, Board-

to-Board, 10 Position, 2.54mm [.1in] Centerline, Right Angle,

Through Hole - Solder

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Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors > AMP-LATCH UNIVERSAL HEADERS



Connector System: Board-to-Board

Number of Positions: 10

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: With

PCB Mount Retention Type: Screw Mount

All AMP-LATCH UNIVERSAL HEADERS (525)

Features

Product Type Features

Operating Voltage

Body Features

Daisy Chain

Connector Profile

Header
Universal Ejection Pin Headers
Connector Assembly
Board-to-Board
Receptacle
Printed Circuit Board
10
Right Angle
2
5000 ΜΩ

250 VAC

Without

Standard



Contact Features

Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
Contact Type	Pin
	15 μin
Contact Mating Area Plating Material	Gold, Gold Flash
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Current Rating (Max)	1 A
Termination Features	
Round Termination Post & Tail Diameter	.64 mm[.025 in]
Termination Post & Tail Length	2.79 mm[.11 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
PCB Mount Alignment	With
Panel Mount Feature	Without
PCB Mount Retention	With
PCB Mount Retention Type	Screw Mount
Mating Alignment Type	Center, Dual Polarizing Bar
Mating Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Housing Color	Black
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	

Dimensions

Shrouded End Dimension	3.81 mm[.15 in]
Connector Length	32 mm[1.26 in]
Connector Height	8.53 mm[.34 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]



Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	90
Packaging Method	Tray
Other	
Comment	Pin headers in 10- and 14-position sizes have only one slot for snap-in polarizer (military polarization), located as shown., Pin headers in 10-position size have only slot for dual polarization, located as shown.

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

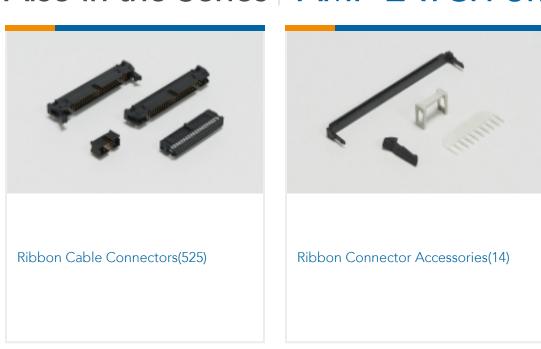


This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMP-LATCH Universal Headers



Customers Also Bought









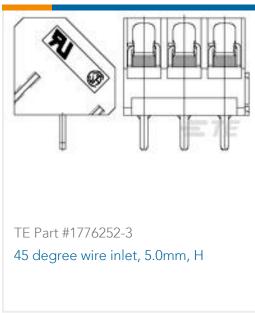














Documents

Product Drawings

010 UNIV HDR RA 4S 15DP STD

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_102159-1_M.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_102159-1_M.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_102159-1_M.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Product Specifications

Product Specification

English

Product Environmental Compliance

TE Material Declaration

English

Instruction Sheets

Instruction Sheet (U.S.)



English

AMP INSTALLATION PROCEDURES FOR AMP-LATCH UNIVERSAL HEADER ASSEMBLIE

English

Agency Approvals

Agency Approval Document

English